STACKUP CROSSECTION - 607-13509-1000-A01.pdf

NOTES: 1. UNLESS OTHERWISE SPECIFIED ON THE 606 FAB DRAWING: WHERE GOLD EDGE FINGERS EXIST,
TARGET THICKNESS APPLIES ONLY TO THE GOLD FINGER REGION, AND DOES NOT INCLUDE SOLDERMASK.

- 2. STRIPLINE LAYERS MAY BE USED FOR PLANE REFERENCES (REF). LAYERS WITHOUT TRACES SHOULD BE CONSIDERED PLANES.
- 3. *DESIGN USES TRACE WIDTHS WITH VARIATION OF +/- 1um COMPARED TO TARGET WIDTH. CONSIDER IMPEDANCE CONTROLLED BASED ON TARGET WIDTH.
- 4. DK VALUES: IMPEDANCE CALCULATIONS ASSUME A DK VALUE BASED ON THE DISTRIBUTION OF MATERIALS AVAILABLE. THE FABRICATOR IS ALLOWED TO ADJUST TRACE WIDTHS +/- 20% FOR NOMINAL LINE WIDTHS OF >0.127mm or +/-0.0254mm FOR TRACE WIDTHS <0.127mm TO COMPENSATE FOR THE Dk VALUE OF THE ACTUAL MATERIAL USED IN THE STACK-UP.
- 5. MULTI PLY CORE IS DENOTED BY x2, x3 IN THE MATERIAL NAME, e.g. EM-890K 0.006 1078(rc63.5)x2 Core
- 6. MATERIAL: HALOGEN FREE.

Target Thickness: 1.57
Tolerance: +0.15/-0.15

Name	Negative Artwork	Layer Usage					
TOP		Signal Layer					
L2		Plane Layer					
L3		Signal Layer					
L4		Signal Layer					
L5		Plane Layer					
воттом		Signal Layer					

Material					
Air					
Soldermask					
Copper 43um (Plated)	0.043				
EM-370(5) 0.0027 1080x1 Prepreg	0.069				
Copper 1oz					
EM-370(5) 0.003 1086x1 Core					
Copper 1oz	0.03				
EM370(5)_PP + Core + PP_0.042					
Copper 1oz	0.03				
EM-370(5) 0.003 1086x1 Core	0.076				
Copper 1oz					
EM-370(5) 0.0027 1080x1 Prepreg					
Copper 43um (Plated)	0.043				
Soldermask	0.018				
Air					

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LEGEND:



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11/27/2019 Drawing units: mm

Sheet 1 of 2

STACKUP IMPEDANCES - 607-13509-1000-A01.pdf (Impedance Tolerance = +/- 10% unless otherwise noted)

Single Ended	SEZ	LW	Ref(above)	Ref(below)
TOP	50.0	0.102			L2
L3	50.0	0.089		L2	L5
L4	50.0	0.089		L2	L5
BOTTOM	50.0	0.102		15	

Differential (Edge)	DEZ	SEZ	LW	LineGap	NeckLW	NeckLineGap	Ref(above)	Ref(below)
TOP	85.0		0.101	0.118				L2
TOP	90.0		0.103	0.16				L2
TOP	95.0		0.1	0.221				L2
L4	90.0		80.0	0.15			L2	L5
BOTTOM	85.0		0.101	0.118			L5	
BOTTOM	90.0		0.103	0.16			L5	
BOTTOM	95.0		0.1	0.221			L5	

LEGEND:

SEZ = Single Ended Impedance
DEZ = Differential Edge Coupled Impedance (pair on one layer)
DBZ = Differential Broadside Coupled Impedance (pair on two layers)



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